

### **Description**

The SI7414DN-T1-E3 uses advanced trench technology

to provide excellent R<sub>DS(ON)</sub>, low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

#### **General Features**

V<sub>DS</sub> = 60V I<sub>D</sub> =30 A

 $R_{DS(ON)} < 30 m\Omega$  @  $V_{GS}=10V$ 

#### **Application**

Battery protection

Load switch

Uninterruptible power supply

## Package Marking and Ordering Information

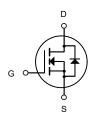
Product ID	Pack	Brand	Qty(PCS)
SI7414DN-T1-E3	DFN3X3-8L	HXY MOSFET	5000

#### Absolute Maximum Ratings (T<sub>c</sub>=25 ℃ unless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	60	V
VGS	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	30	А
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	16	А
IDM	Pulsed Drain Current <sup>2</sup>	90	А
EAS	Single Pulse Avalanche Energy <sup>3</sup>	42	mJ
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup>	33	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R₀JA	Thermal Resistance Junction-ambient <sup>1</sup>	62	°C/W
R₀JC	Thermal Resistance Junction-Case <sup>1</sup>	3.79	°C/W



DFN3X3-8L



N-Channel MOSFET



# Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
BV <sub>DSS</sub>	Drain-Sourtce Breakdown Voltage	V <sub>GS</sub> =0V,I <sub>D</sub> =250 μ A	60			V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>GS</sub> =0V, V <sub>DS</sub> =60V			1	μA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm 20V$ , $V_{DS}=0A$			±100	nA
V <sub>GS(th)</sub>	GATE-Source Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250 μ A	1.2	1.8	2.5	V
		V <sub>GS</sub> =10V,I <sub>D</sub> =20A		24	30	m Ω
R <sub>DS(ON)</sub>	Drain-Source On Resistance <sup>3</sup>	V <sub>GS</sub> =4.5V,I <sub>D</sub> =20A		31	40	
C <sub>iss</sub>	Input Capacitance			1060		
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V, f=1MHz		64		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			54		
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD}$ =30V , $V_{GS}$ =10V , $I_{D}$ =20A, $R_{G}$ =3 $\Omega$		8.4		ns
t <sub>r</sub>	Rise Time			8.5		ns
t <sub>d(off)</sub>	Turn-Off Delay Time			36		ns
t <sub>f</sub>	Fall Time			5		ns
$\mathbf{Q}_{\mathbf{g}}$	Total Gate Charge	$V_{DS}$ =30V , $V_{GS}$ =10V , $I_D$ =20A		26		nC
$\mathbf{Q}_{gs}$	Gate-Source Charge			5.7		nC
$Q_{\rm gd}$	Gate-Drain "Miller" Charge			5.2		nC
Is	Continuous Source Current	VG=VD=0V			20	А
I <sub>SM</sub>	Pulsed Source Current	VG=VD=0V			90	А
V <sub>SD</sub>	Forward on voltage	I <sub>S</sub> =20A,V <sub>GS</sub> =0V			1.2	V
Trr	Body Diode Reverse Recovery Time	- IF=20A, dI/dt=100A/μs		18		nS
Qrr	Body Diode Reverse Recovery Charge			13		nC

#### **Notes:**

- 1) L=0.5mH, VDD=30V, Start TJ=25°C.
- 2) Limited by maximum junction temperature.
- 3) Repetitive Rating: Pulse width limited by maximum junction temperature



#### **Typical Characteristics**

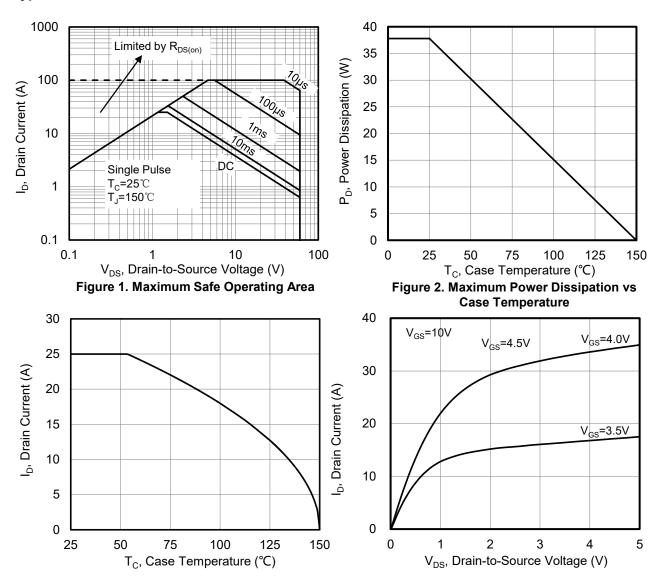


Figure 3. Maximum Continuous Drain Current vs **Case Temperature** 

Figure 4. Typical output Characteristics

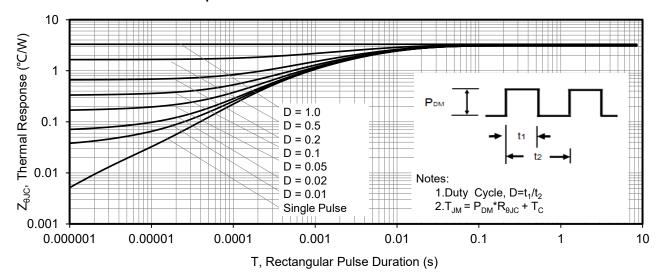
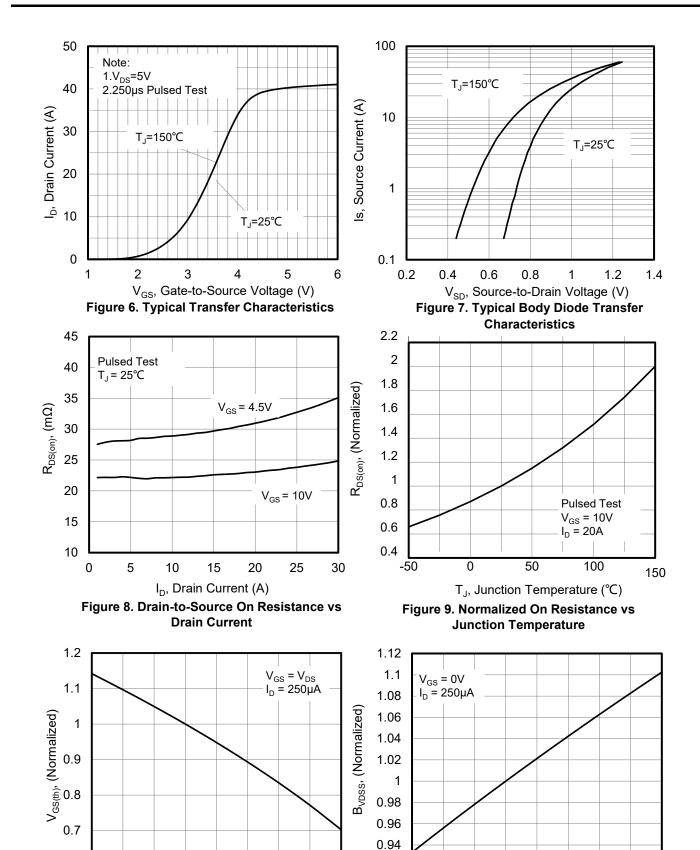


Figure 5. Maximum Effective Thermal Impedance, Junction to Case



0.92

-50

50

Figure 11. Normalized Breakdown Voltage vs

**Junction Temperature** 

T<sub>J</sub>, Junction Temperature (°C)

100

150

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50

T<sub>J</sub>, Junction Temperature (°C)

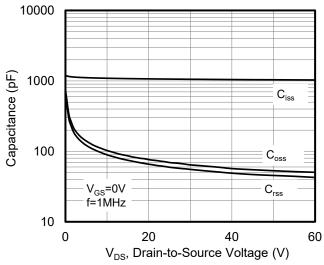
Figure 10. Normalized Threshold Voltage vs Junction Temperature

100

0.6

-50

150





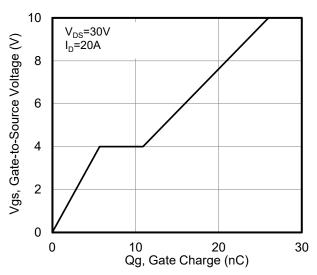
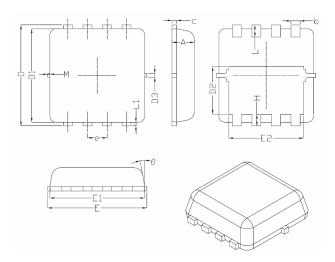


Figure 13. Typical Gate Charge vs Gate to Source Voltage

# **DFN3X3-8L Package Information**



Symbol	Dimensions In Millimeters			
	Min.	Nom.	Max.	
A	0.70	0.75	0.80	
b	0.25	0.30	0.35	
С	0.10	0.15	0.25	
D	3.25	3.35	3.45	
D1	3.00	3.10	3.20	
D2	1.48	1.58	1.68	
D3	-	0.13	-	
E	3.20	3.30	3.40	
E1	3.00	3.15	3.20	
E2	2.39	2.49	2.59	
е	0.65	5BSC		
Н	0.30	0.39	0.50	
L	0.30	0.40	0.50	
L1	-	0.13	-	
M	*	*	0.15	
θ		10 <sup>°</sup>	12 <sup>°</sup>	



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